







IFN5564, IFN5565, IFN5566 Dual Matched N-Channel JFET

Features

InterFET N0072S Geometry
Low Noise: 2.5 nV/VHz Typical
Low Leakage: 10 pA Typical

Low Input Capacitance: 6.5 pF Typical

RoHS Compliant

• SMT, TH, and Bare Die Package options.

Applications

- · Wide Band Differential Amplifier
- Commutators

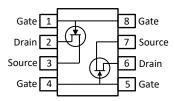
Description

The -40V InterFET IFN5564, IFN5565, and IFN5566 JFET's are targeted for wide bandwith differential amplifiers and commutators. Gate leakages are less than 10pA at room temperatures. The IFN5564 is matched down to 5mV. The TO-71 package is hermetically sealed and suitable for military applications. Custom specifications, matching, and packaging options are available.

Gate Source TO-71 Bottom View Orain Source Source To-71 Bottom View



SOIC8 Top View





Product Summary

	Parameters	IFN5564 Min	IFN5565 Min	IFN5566 Min	Unit
BV _{GSS}	Gate to Source Breakdown Voltage	-40	-40	-40	V
I _{DSS}	Drain to Source Saturation Current	5	5	5	mA
V _{GS(off)}	Gate to Source Cutoff Voltage	-0.5	-0.5	-0.5	V
GFS	Forward Transconductance	7000	7000	7000	μS

Ordering Information Custom Part and Binning Options Available

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Part Number	Description	Case	Packaging			
IFN5564; IFN5565; IFN5566	Through-Hole	TO-71	Bulk			
SMP5564; SMP5565; SMP5566	Through-Hole	SOIC8	Bulk			
SMP5564TR; SMP5565TR;	7" Tape and Reel: Max 500 Pieces		Minimum 500 Pieces			
SMP5566TR	13" Tape and Reel: Max 2,500 Pieces	SOIC8	Tape and Reel			
IFN5564COT; IFN5565COT;						
IFN5566COT *	Chip Orientated Tray (COT Waffle Pack)	СОТ	70/Waffle Pack			
IFN5564CFT; IFN5565CFT;						
IFN5566CFT *	Chip Face-up Tray (CFT Waffle Pack)	CFT	70/Waffle Pack			

^{*} Bare die packaged options are designed for matched specifications but not 100% tested



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









Electrical Characteristics

Maximum Ratings (@ TA = 25°C, Unless otherwise specified)

	Parameters	Value	Unit
V_{RGS}	Reverse Gate Source and Gate Drain Voltage	-40	V
I _{FG}	Continuous Forward Gate Current	50	mA
P_{D}	Continuous Device Power Dissipation	650	mW
Р	Power Derating	3.3	mW/°C
TJ	Operating Junction Temperature	-55 to 150	°C
Tstg	Storage Temperature	-65 to 200	°C

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

			IFN5564, IFN5565, IFN5566		
	Parameters	Conditions	Min	Max	Unit
V _{(BR)GSS}	Gate to Source Breakdown Voltage	I _G = -1μΑ,V _{DS} = 0V	-40		V
I _{GSS}	Gate to Source Reverse Current	$V_{GS} = -20V$, $V_{DS} = 0V$, $T_A = 25$ °C $V_{GS} = -20V$, $V_{DS} = 0V$, $T_A = 150$ °C		-100 -200	pA nA
V _{GS(OFF)}	Gate to Source Cutoff Voltage	V _{DS} = 15V, I _D = 1nA	-0.5	-3	V
V _{GS(F)}	Gate Source Forward Voltage	$V_{DS} = 0V$, $I_G = 2mA$		1	V
I _{DSS}	Drain to Source Saturation Current	$V_{DS} = 15V$, $V_{GS} = 0V$ (Pulsed)	5	30	mA
R _{DS(ON)}	Static Drain to Source ON Resistance	$V_{GS} = 0V$, $I_D = 1mA$		100	Ω

Dynamic Characteristics (@ TA = 25°C, Unless otherwise specified)

-	· ·	c, official wise specifical		IFN5564, IFN5	564, IFN5565, IFN5566		
Parameters		Conditions		Min	Max		Unit
G _{FS}	Forward Transconductance	$V_{DS} = 15V$, $I_D = 2mA$, $f = V_{DS} = 15V$, $I_D = 2mA$, $f = 15V$	7000 7000	12500		μhmo	
Gos	Output Conductance	V _{DS} = 15V, I _D = 2mA f =		45		μhmo	
C _{iss}	Input Capacitance	V _{DS} = 15V, I _D = 2mA, f = 1MHz			12		pF
C _{rss}	Reverse Capacitance	V _{DS} = 15V, I _D = 2mA, f = 1MHz			3		pF
NF	Noise Figure	V_{DS} = 15V, I_D = 2mA, f = 10Hz, R_G = 1M Ω			1		dB
e _n	Equivalent Circuit Input Noise Voltage	V _{DS} = 15V, I _D = 2mA, f = 10Hz			50		nV/√Hz
I _{DSS1} /I _{DSS2}	Saturation Drain Current Ratio	V _{DS} = 15V, V _{GS} = 0V (Pulsed)		0.95	1		-
V _{GS1} – V _{GS2}	Differential Gate Source Voltage	V _{DS} = 15V, I _D = 2mA	IFN5564 IFN5565 IFN5566		5 10 20		mV
$\frac{\left V_{GS1}-V_{GS2}\right }{\Delta T}$	Differential Gate Source Voltage with Temperature	$V_{DS} = 15V$, $I_D = 2mA$ $T_A = 25^{\circ}C$ to -55 $^{\circ}C$ [0.8,2,4] $T_A = 25^{\circ}C$ to 125 $^{\circ}C$ [1,2.5,5]			0.8 1 2 2.5 4 5		mV/°C
gfs1/gfs2	Transconductance Ratio	V _{DS} = 15V, I _D = 2mA	IFN5564 IFN5565 IFN5566	0.95 0.9 0.9	1 1 1		-

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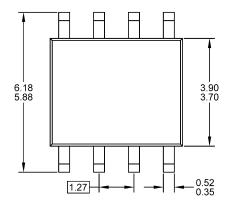


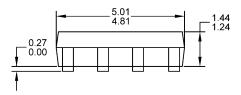


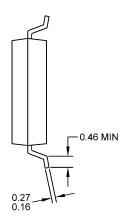


SOIC8 Mechanical and Layout Data

Package Outline Data

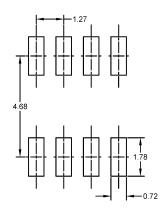






- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.21 grams
- 3. Molded plastic case UL 94V-0 rated
- For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
- Bulk product is shipped in standard ESD shipping material
- 6. Refer to JEDEC standards for additional information.

Suggested Pad Layout



- 1. All linear dimensions are in millimeters.
- The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.



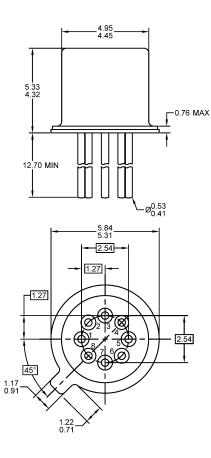






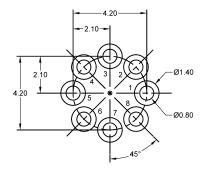
TO-71 Mechanical and Layout Data

Package Outline Data



- 1. All linear dimensions are in millimeters.
- Eight leaded device. Not all leads are shown in drawing views.
- 3. Some package configurations will not populate pin 8 and/or pin 4.
- 4. Package weight approximately 0.35 grams
- Bulk product is shipped in standard ESD shipping material
- 6. Refer to JEDEC standards for additional information.

Suggested Bent Lead Through-Hole Layout



- 1. All linear dimensions are in millimeters.
- 2. Pads 8 and/or pad 4 can be eliminated for devices with less pins.
- The suggested land pattern dimensions have been provided as an eight pin bent lead reference only. A more robust pattern may be desired for wave soldering or reduced pin count.

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